



Dec. 2024 Ver.9.0
TDK Corporation

Multilayer Antenna

For 2.4GHz W-LAN & Bluetooth

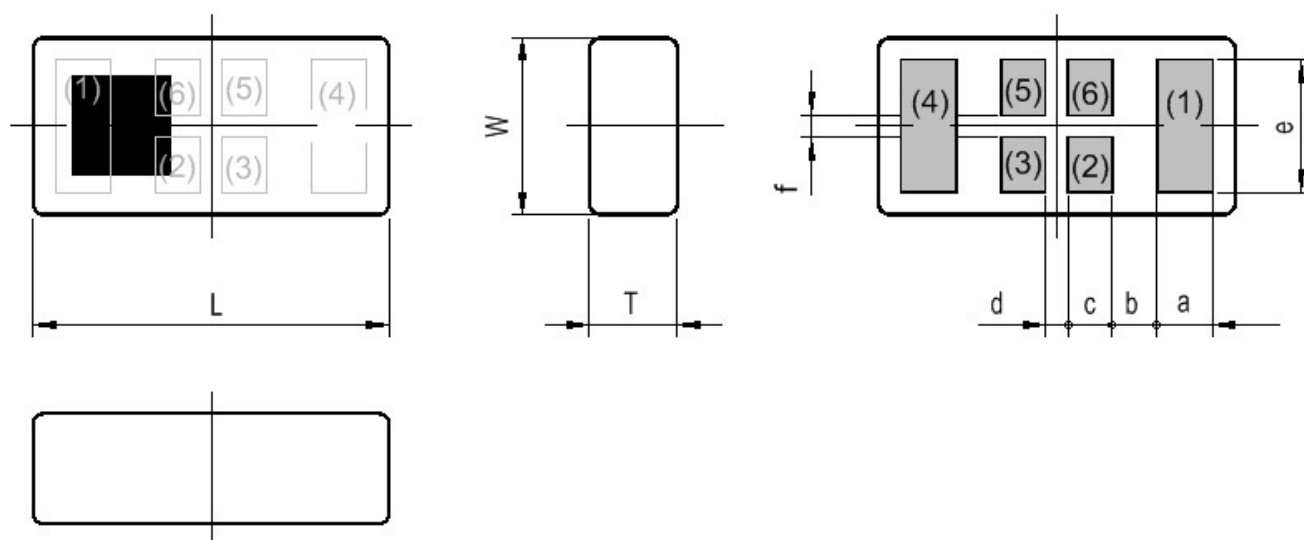
ANT Series 1.6x0.8mm [EIA 0603] TYPE

P/N: **ANT162442ST-1000AM1**

***AEC-Q200 (-40 ~ 85 [deg.C])
qualified component family***

ANT162442ST-1000AM1

■ SHAPES AND DIMENSIONS



Dimensions (mm)

L	W	T	a	b	c	d	e	f
1.60	0.80	0.40	0.215	0.25	0.20	(0.10)	0.63	(0.10)
+/-0.10	+/-0.10	Max	+/-0.10	+/-0.10	+/-0.10		+/-0.10	

Terminal functions

(1)	Radiator electrode
(2)	Dummy pad
(3)	Dummy pad
(4)	Feed point
(5)	Dummy pad

(6)	Dummy pad
-----	-----------

*Terminal (2),(3),(5) and (6) :Connected in inner structure

■ TERMINATION FINISH

Material
Au plate

ANT162442ST-1000AM1

ELECTRICAL CHARACTERISTICS

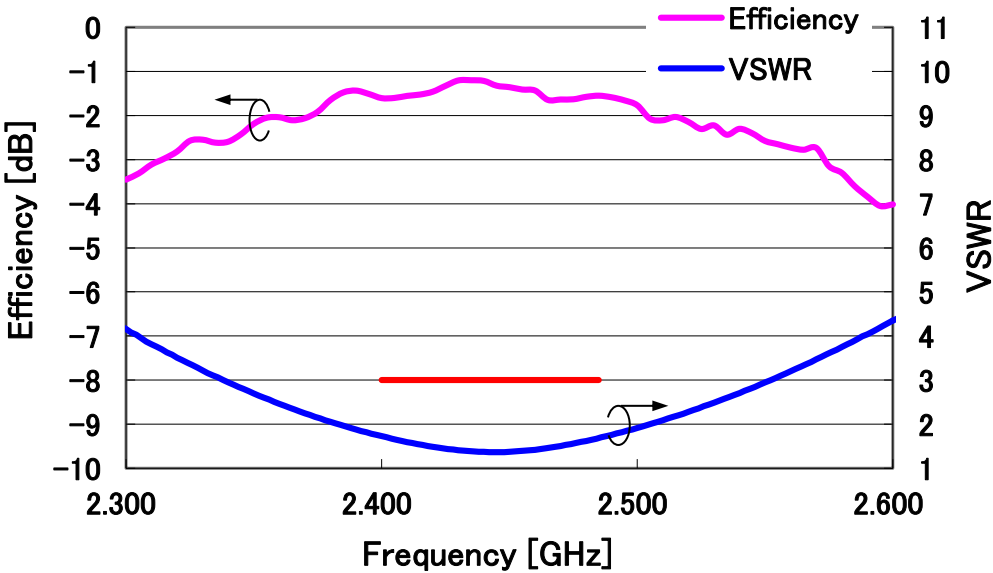
(Measurement)

Parameter	Frequency (MHz)	TDK Spec		
		Min.	Typ.	Max.
VSWR	2400 to 2484	-	1.60	3.0
Antenna Gain (dBi)**	2400 to 2484	-	1.6	-
Polarization		Linear		
PCB Size (mm)		50 x 20		
Antenna keep-out Area (mm)		5 x 3		
Characteristic Impedance (ohm)		50 (Nominal)		

* This is typical antenna performance with the standard PCB.
** Reference value

FREQUENCY CHARACTERISTICS

Note: Tested antenna has been soldered. Evaluation board size is 50x20x1 mm.
Efficiency and VSWR



ANT162442ST-1000AM1

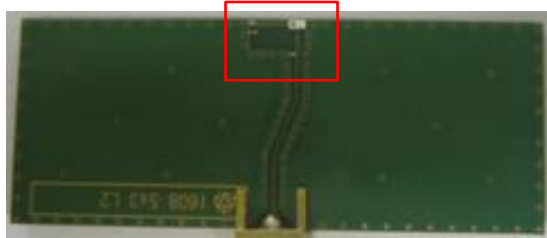
■ MAXIMUM RATINGS

Parameter	TDK Spec	Conditions
Operating temperature (°C)	−40 to +85 °C	
Storage temperature (°C)	−40 to +85 °C	
Power Handling (W) *1	0.8	CW
Human Body Model : HBM @ Each Port (V)	+/-1000	100pF / 1500ohm
Machine Model : MM @ Each Port (V)	+/-150	200pF / 0ohm
Charged Device Model : CDM @ Each Port (V)	+/-500	Humidity : 60%RH max

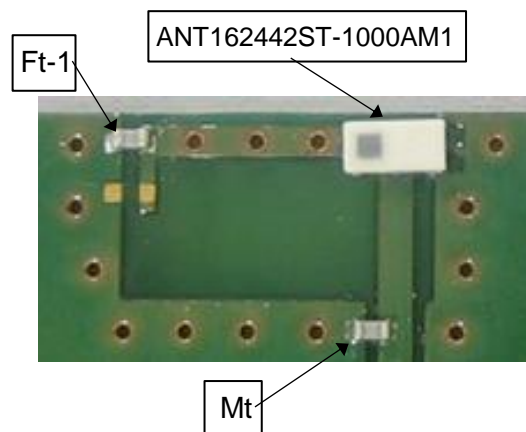
*1 : Refer to 3GPP TS 38.101-1 V15.2.0

ANT162442ST-1000AM1

EVALUATION BOARD



PCB size : 50mm x 20mm x 1mm
Antenna area : 5 x 3 mm

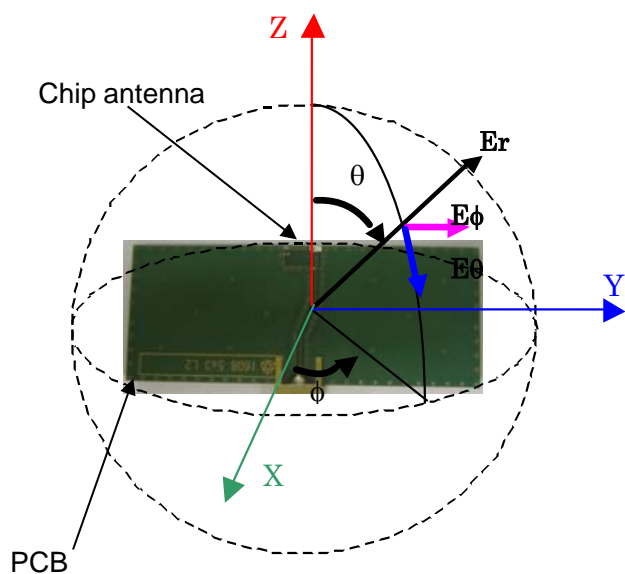


	Element Value
Ft-1	6.2pF
Mt	0.8pF

This evaluation board layout example is defined based on TDK standard.
Other board layouts can be used by optimizing their design.
Matching element values can be selected depending on the board layouts.
Getting more support, please access our website.

[Contact | TDK](#)

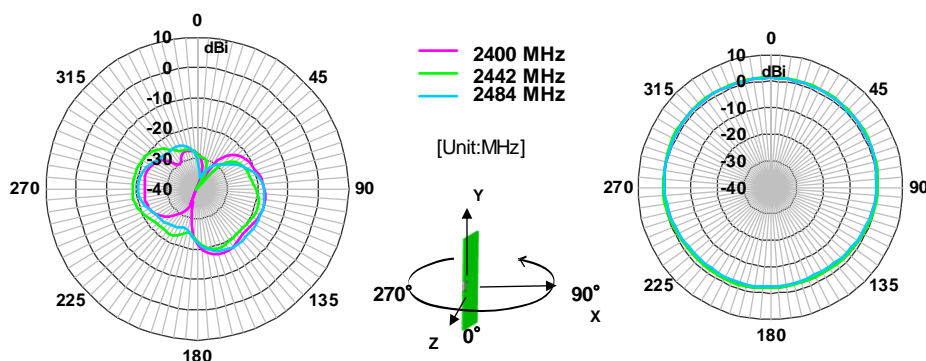
Measurement condition for Radiation pattern



ANT162442ST-1000AM1

Radiation Pattern

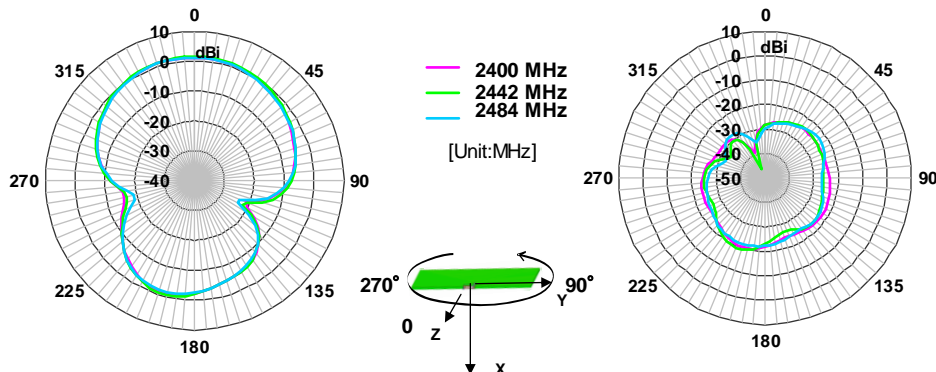
Note: Tested antenna has been soldered. Evaluation board size is 50x20x1 mm.
2.4GHz band

**Horizontal Polarization**

Frequency [MHz]	2400	2442	2484
Average[dBi]	-21.5	-21.5	-21.3
Maximum[dBi]	-16.9	-18.5	-17.2
Minimum[dBi]	-46.0	-40.8	-36.4

Vertical Polarization

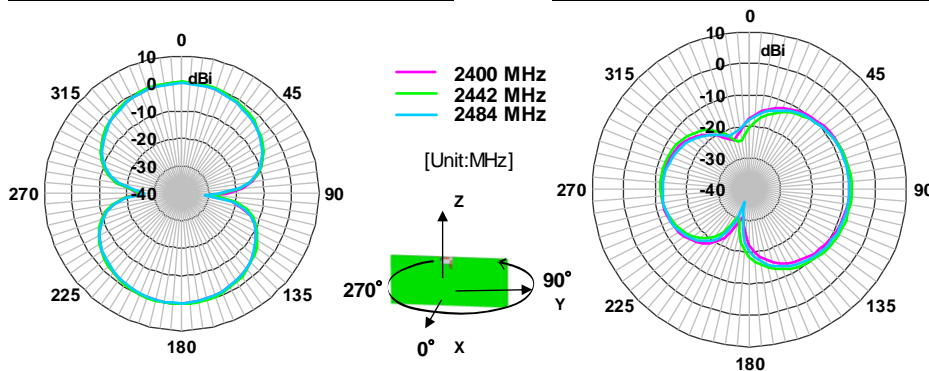
Frequency [MHz]	2400	2442	2484
Average[dBi]	0.0	0.3	-0.2
Maximum[dBi]	1.3	1.6	1.2
Minimum[dBi]	-2.4	-2.2	-3.0

**Horizontal Polarization**

Frequency [MHz]	2400	2442	2484
Average[dBi]	-2.9	-2.6	-3.1
Maximum[dBi]	1.3	1.6	1.2
Minimum[dBi]	-21.5	-21.9	-23.6

Vertical Polarization

Frequency [MHz]	2400	2442	2484
Average[dBi]	-24.1	-24.7	-24.8
Maximum[dBi]	-20.2	-19.1	-21.5
Minimum[dBi]	-39.2	-46.1	-34.9

**Horizontal Polarization**

Frequency [MHz]	2400	2442	2484
Average[dBi]	-3.1	-2.7	-3.2
Maximum[dBi]	0.2	0.6	0.1
Minimum[dBi]	-29.8	-28.5	-31.3

Vertical Polarization

Frequency [MHz]	2400	2442	2484
Average[dBi]	-12.2	-11.8	-12.3
Maximum[dBi]	-8.0	-7.5	-8.2
Minimum[dBi]	-31.2	-30.5	-35.8

All specifications are subject to change without notice.

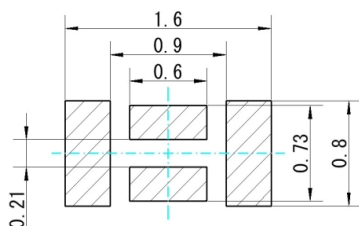
When using these products, be sure to request the delivery specifications.

ANT162442ST-1000AM1

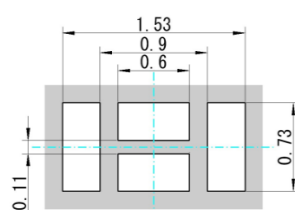
RECOMMENDED LAND PATTERN

Recommend land pattern and solder resist pattern

< Land pattern >

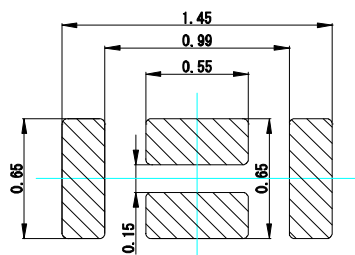


< Solder resist pattern >



- Center line of Chip
- Land Pattern
- Resist Pattern

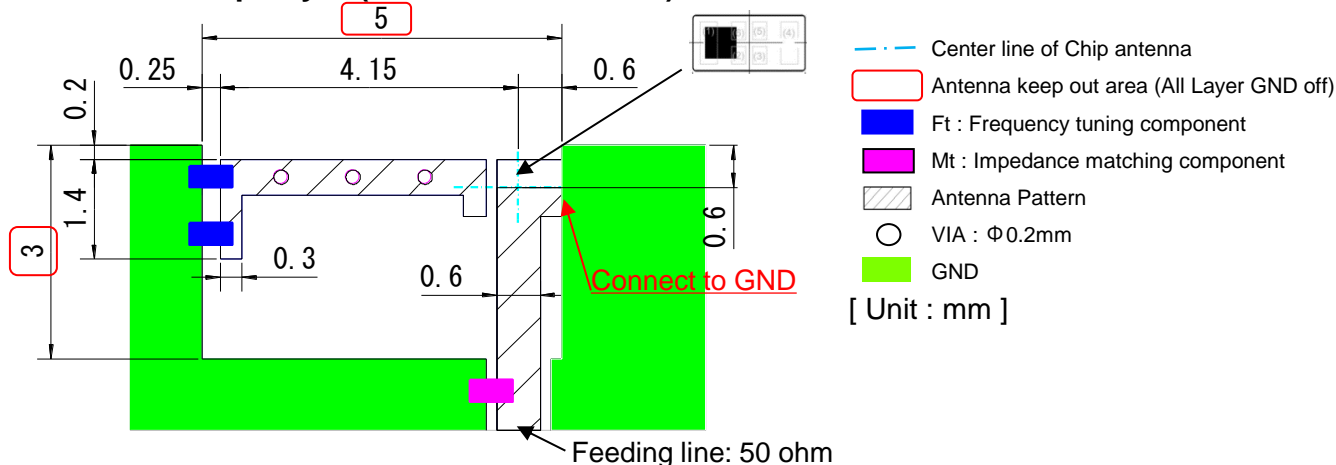
Recommend aperture size of metal mask for solder



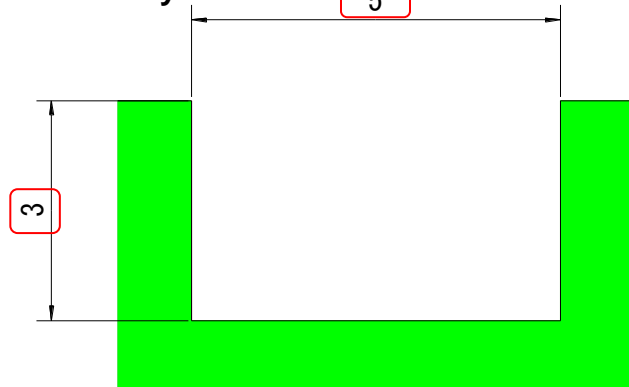
- Center line of Chip
- Aperture of metal

Example of Antenna pattern layout (TDK Standard PCB)

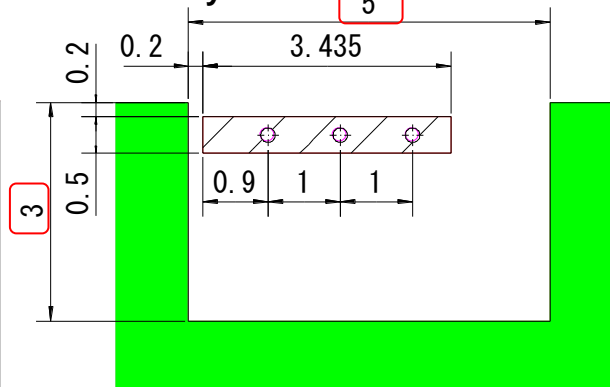
<Top Layer (Parts mounted side) >



<Inner Layer >



<Bottom Layer >



All specifications are subject to change without notice.

When using these products, be sure to request the delivery specifications.

Dec. 2024 Ver.9.0
TDK Corporation

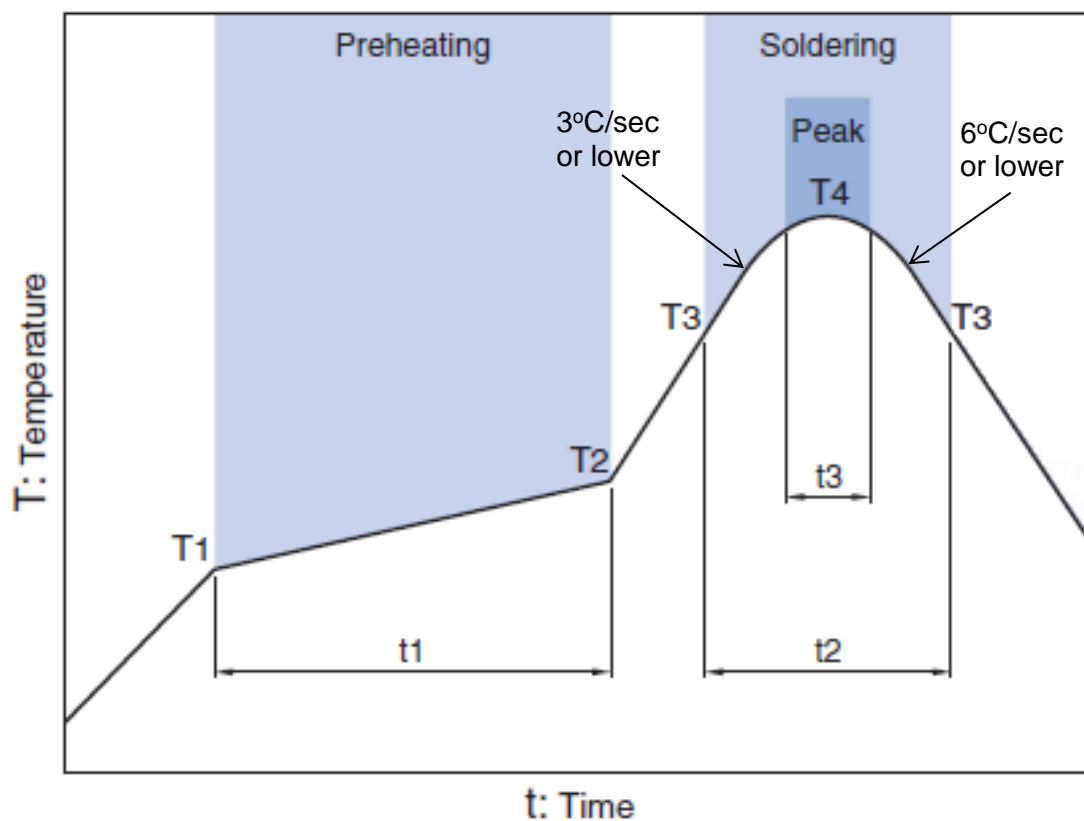
ANT162442ST-1000AM1

■ ENVIROMENT INFORMATION

RoHS Statement
RoHS Compliance

TDK Corporation

RECOMMENDED REFLOW PROFILE



Preheating			Soldering			
			Critical zone (T3 to T4)		Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3 *
150°C	200°C	60 to 120sec	217°C	60 to 120sec	240 to 260°C	30 sec Max

* t3 : Time within 5°C of actual peak temperature

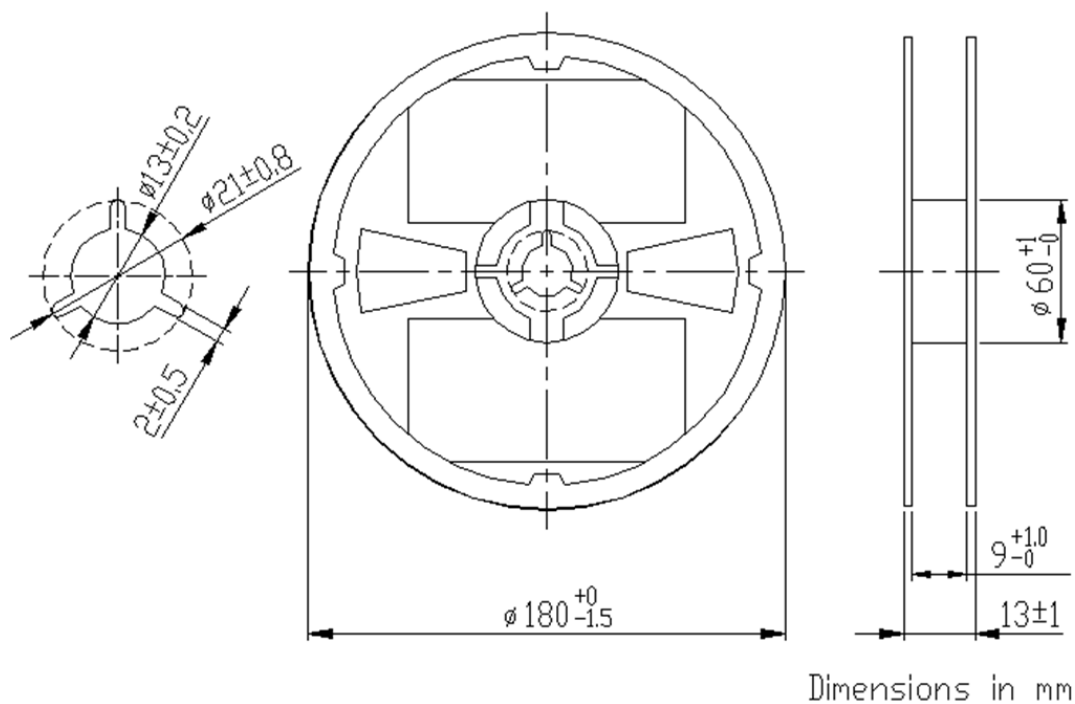
The maximum number of reflow is 3.

Note: Lead free solder is recommended.
Recommended solder is Sn-3.0Ag-0.5Cu. (M705 by Senju Metal Industry)

ANT162442ST-1000AM1

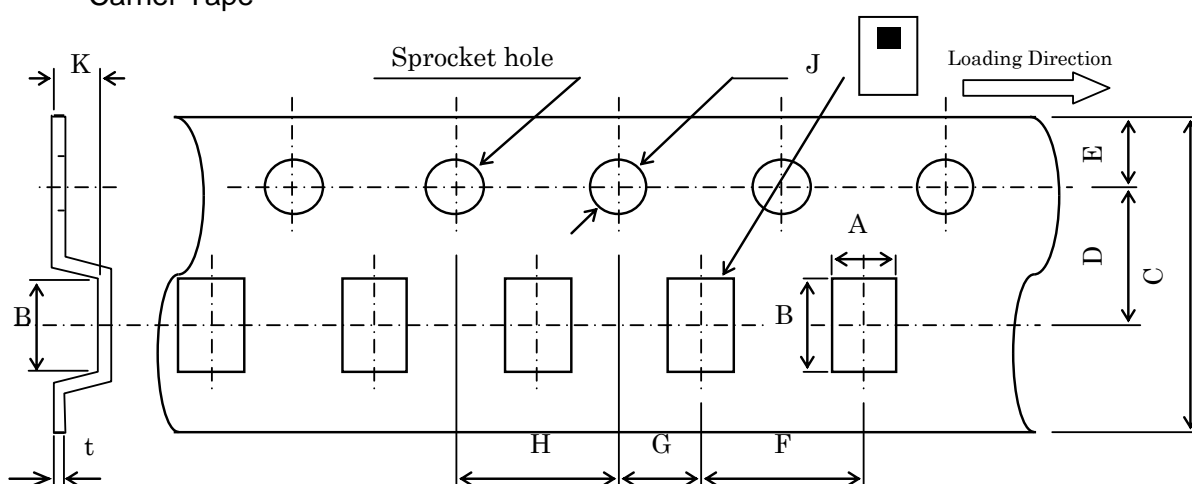
PACKAGING STYLE

Reel Dimensions



Carrier Tape

Material of the carrier tape : PS



Dimensions (mm)

A	B	C	D	E	F	G	H	J	K	t
0.97	1.8	8.0	3.5	1.75	4.0	2.0	4.0	1.5	0.55	0.25
± 0.05	± 0.05	± 0.2	± 0.05	± 0.1	± 0.1	± 0.05	± 0.1	$\pm 0.1/-0$	MAX	± 0.05

STANDARD PACKAGE QUANTITY
(pieces/reel)

4,000

All specifications are subject to change without notice.

When using these products, be sure to request the delivery specifications.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDERS

The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.

Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this catalog.

- | | |
|---|--|
| (1) Aerospace/Aviation equipment | (8) Public information-processing equipment |
| (2) Transportation equipment (electric trains, ships, etc.) | (9) Military equipment |
| (3) Medical equipment | (10) Electric heating apparatus, burning equipment |
| (4) Power-generation control equipment | (11) Disaster prevention/crime prevention equipment |
| (5) Atomic energy-related equipment | (12) Safety equipment |
| (6) Seabed equipment | (13) Other applications that are not considered general-purpose applications |
| (7) Transportation control equipment | |

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.

- All specifications are subject to change without notice.
- Before using these products, be sure to request the delivery specifications.